

FDPF045N10A N-Channel PowerTrench[®] MOSFET 100 V, 164 A, 4.5 mΩ

Features

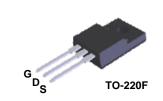
- + $R_{DS(on)}$ = 3.7 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 67 A
- Fast Switching Speed
- Low Gate Charge, $Q_G = 57 \text{ nC(Typ.)}$
- High Performance Trench Technology for Extremely Low $R_{\text{DS}(\text{on})}$
- High Power and Current Handling Capability
- RoHS Compliant

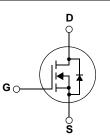
Description

This N-Channel MOSFET is produced using Fairchild Semiconductor[®]'s advance PowerTrench[®] process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Applications

- Synchronous Rectification for ATX / Server / Telecom PSU
- Motor drives and Uninterruptible Power Supplies
- Micro Solar Inverter





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted*

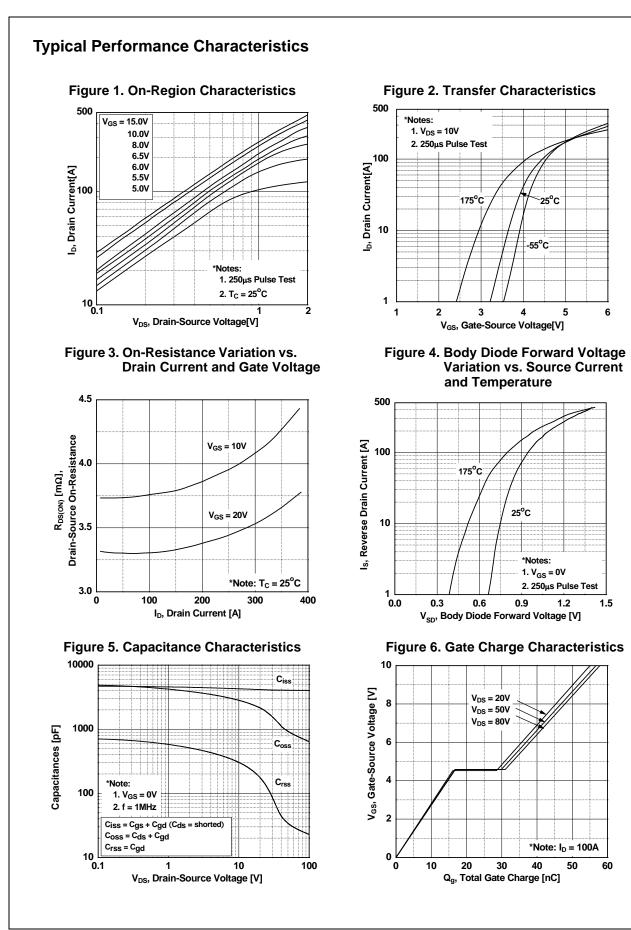
Symbol		FDPF045N10A	Unit			
V _{DSS}	Drain to Source Voltage	in to Source Voltage				
V _{GSS}	Gate to Source Voltage			±20	V	
ID	Drain Current	- Continuous (T _C = 25 ^o C)		67		
	Drain Current	- Continuous (T _C = 100 ^o C)		47	— A	
I _{DM}	Drain Current	- Pulsed (Note 1)		268	А	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			637	mJ	
dv/dt	Peak Diode Recovery dv/dt (N		(Note 3)	6.0	V/ns	
P _D	Dower Discipation	$(T_{C} = 25^{\circ}C)$		43	W	
	Power Dissipation	- Derate above 25°C		0.29	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +175	°C	
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C	

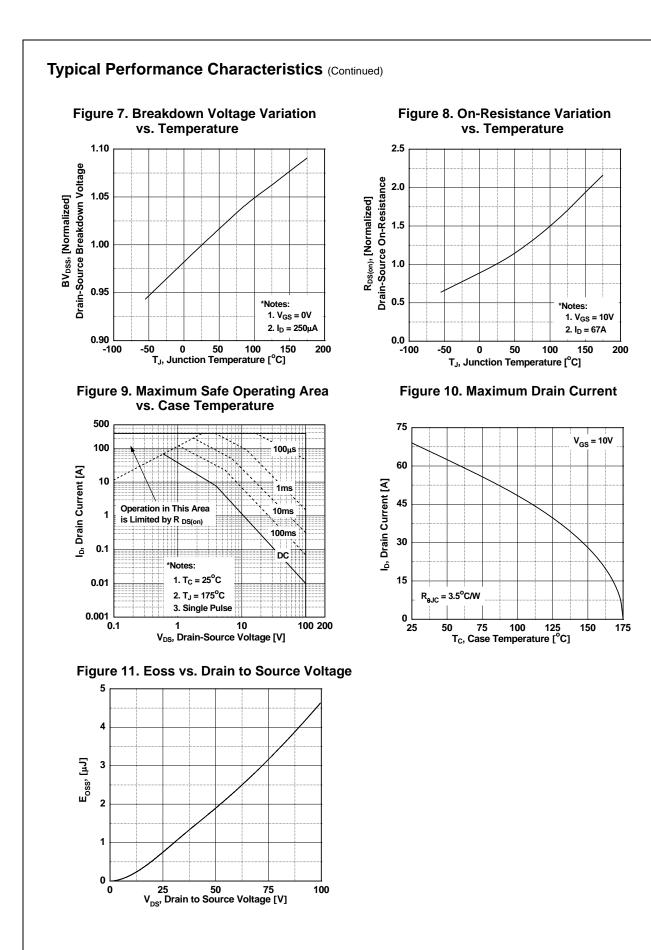
Thermal Characteristics

Symbol	Parameter	FDPF045N10A	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	3.5	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max.	62.5	°C/vv

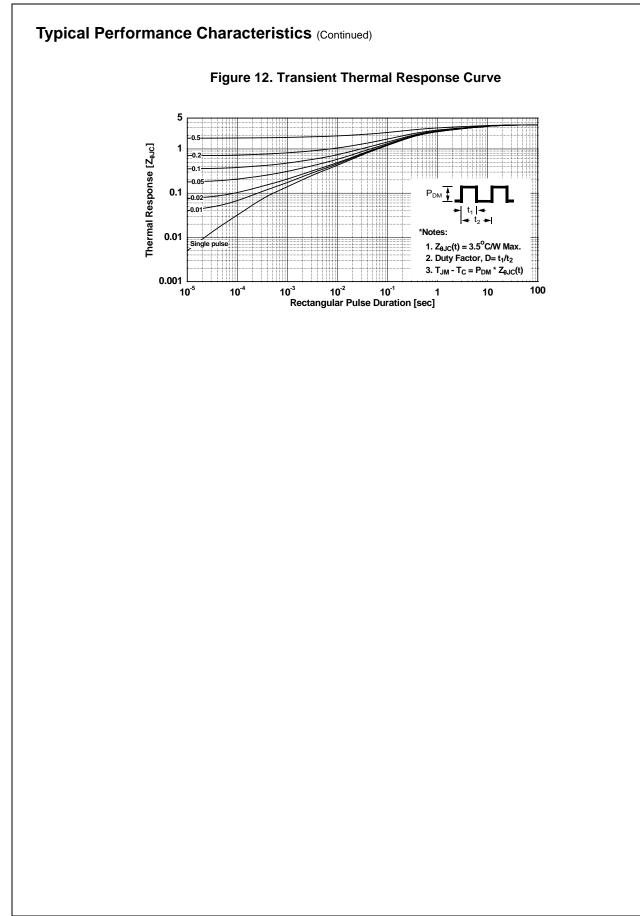
March 2013

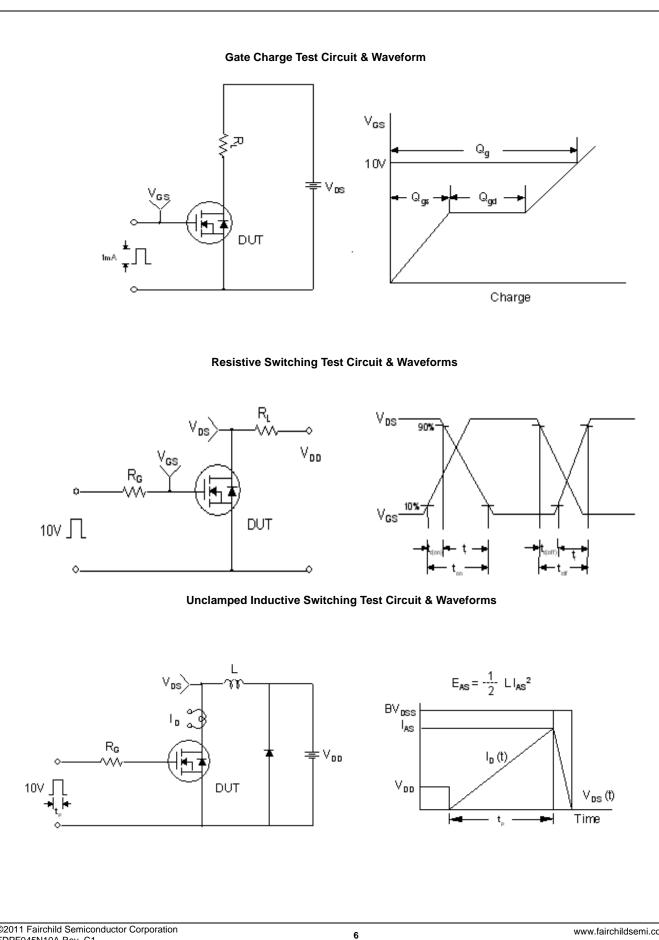
Device Ma	Device Marking Device Pack		Packag	e R	eel Size	Тар	e Width		Quantit	у
FDPF045	•		TO-220	F	-		-		50	
Electrica	I Chai	racteristics T _c =	25ºC unless o	otherwise noted						
Symbol		Parameter		Test Conditions			Min.	Тур.	Max.	Unit
Off Charac	cteristic	s								
BV _{DSS}	Drain te	in to Source Breakdown Voltage		$I_D = 250 \mu A, V_{GS} = 0 V$			100	-	-	V
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature		ure	$I_D = 250 \mu A$, Referenced to $25^{\circ}C$			-	0.06	-	V/ºC
1	Zoro C	Zero Gate Voltage Drain Current		V _{DS} = 80V, V _{GS} = 0V			-	-	1	۸
DSS	Zeio G	ale vollage Drain Cum	ent	$V_{DS} = 80V, T_{C}$	= 150°C		-	-	500	μA
I _{GSS}	Gate to	Body Leakage Currer	nt	$V_{GS} = \pm 20V, V$	_{DS} = 0V		-	-	±100	nA
On Charac	teristic	S								
V _{GS(th)}	Gate Threshold Voltage			$V_{GS} = V_{DS}, I_{D}$	= 250µA		2.0	-	4.0	V
R _{DS(on)}	Static I	tatic Drain to Source On Resistance		$V_{GS} = 10V, I_{D}$			-	3.7	4.5	mΩ
9 _{FS}	Forwar	d Transconductance		$V_{DS} = 10V, I_{D} = 67A$			-	127	-	S
Dynamic (Charact	eristics								
C _{iss}	Input C	t Capacitance ut Capacitance erse Transfer Capacitance		V 50V V 0V			-	3961	5270	pF
C _{oss}	Output			──V _{DS} = 50V, V _{GS} = 0V ──f = 1MHz		-	925	1230	pF	
C _{rss}	Revers			1 - 1101112			-	34	-	pF
C _{oss} (er)	Energy	y Releted Output Capacitance		$V_{DS} = 50V, V_{C}$	_{SS} = 0V		-	1521	-	pF
Q _{g(tot)}	Total G	al Gate Charge at 10V te to Source Gate Charge te Charge Threshold to Plateau		$V_{GS} = 10V, V_{DS} = 50V$ $I_D = 100A$		-	57	74	nC	
Q _{gs}	Gate to					-	17	-	nC	
Q _{gs2}	Gate C					-	8	-	nC	
Q _{gd}	Gate to	Drain "Miller" Charge					-	13	-	nC
Switching	Charac	teristics								
t _{d(on)}	Turn-On Delay Time						-	23	56	ns
t _r	Turn-O	n Rise Time		$V_{DD} = 50V, I_D = 100A$ $V_{GS} = 10V, R_{GEN} = 4.7\Omega$		-	26	62	ns	
t _{d(off)}	Turn-O	ff Delay Time				-	50	110	ns	
t _f	Turn-O	ff Fall Time		(Note 4)			-	15	40	ns
ESR	Equival	ent Series Resistance	(G-S)	f = 1MHz			-	1.9	-	Ω
Drain-Sou	rce Dio	de Characteristic	S							
I _S	Maximum Continuous Drain to Source Diod			de Forward Current			-	-	67	Α
I _{SM}	Maximum Pulsed Drain to Source Diode F		Irce Diode For	orward Current			-	-	268	Α
V	Drain to	Drain to Source Diode Forward Voltage		$V_{GS} = 0V, I_{SD} = 67A$			-	-	1.3	V
V _{SD}	Reverse	Reverse Recovery Time		V _{GS} = 0V, V _{DD} = 50V, I _{SD} = 100A			-	75	-	ns
<u>VSD</u> t _{rr}				$dI_F/dt = 100A/\mu s$			-	120	-	nC





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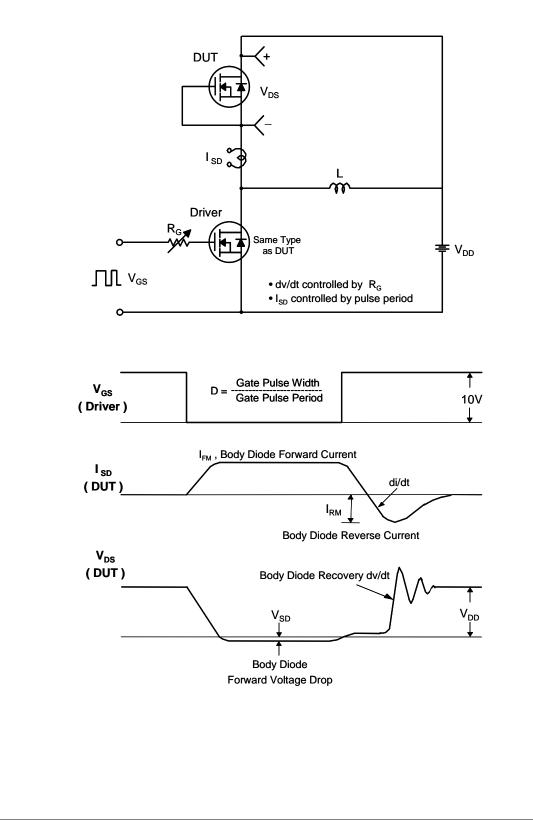




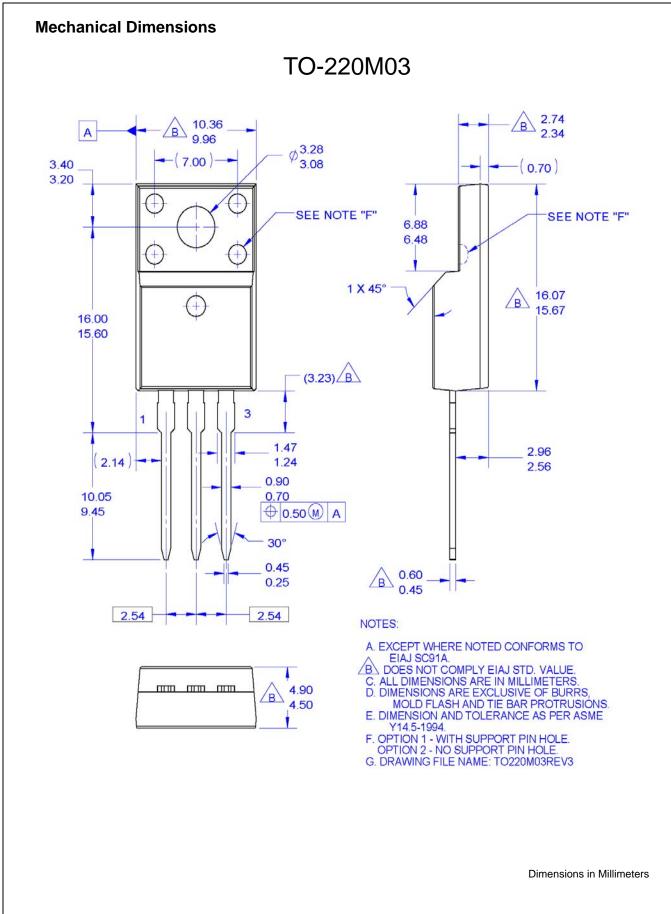
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9